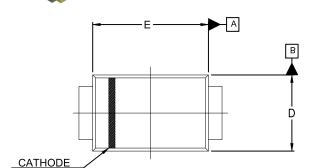




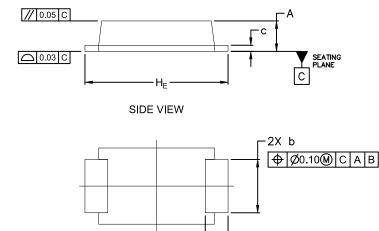
DATE 14 JUL 2020



TOP VIEW

BOTTOM VIEW

IDENTIFIER

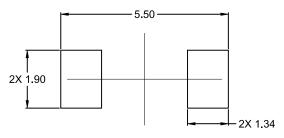


2X L

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS DIMENSIONS D & E ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
b	1.25	1.60	1.90	
С	0.10	_	0.25	
D	2.30	2.50	2.70	
E	3.60	3.95	4.30	
H _E	4.40	4.80	5.20	
L	0.50	0.75	0.95	



RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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	DESCRIPTION:	SMA-FL		PAGE 1 OF 1	

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